

## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/103,873	06/24/1998	4/1998 YOSHIHISA NAGANO YAO-3950		3577	
7:	590 09/24/2002				
ANDREW L NEY			EXAMINER		
RATNER & P	RESTIA	DIAZ IOSE P			
SUITE 301 ONE WESTLAKES BERWYN			DIAZ, JOSE K		
P O BOX 980			ART UNIT	DADED MUMDED	
VALLEY FORGE, PA 194820980			ARTONII	FAFER NOMBER	
			2815	EXAMINER DIAZ, JOSE R T PAPER NUMBER	
	•	DATE MAILED: 09/24/2002			

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)	
•	<b></b>	09/103,873	NAGANO ET AL.	1
Office Action Summary		Examin r	Art Unit	
		José R Díaz	2815	
erioa to	• •	appears on the cover sheet wit	h the correspondence address	;
THE N - Extendafter of the second of the sec	DRTENED STATUTORY PERIOD FOR REIMAILING DATE OF THIS COMMUNICATION sions of time may be available under the provisions of 37 CFR SIX (6) MONTHS from the mailing date of this communication. period for reply specified above is less than thirty (30) days, a speriod for reply is specified above, the maximum statutory perion to reply within the set or extended period for reply will, by statistically received by the Office later than three months after the made patent term adjustment. See 37 CFR 1.704(b).	N. 1.136(a). In no event, however, may a re reply within the statutory minimum of thirty od will apply and will expire SIX (6) MONT tute. cause the application to become ABA	oly be timely filed  (30) days will be considered timely.  HS from the mailing date of this communi	cation.
1)🖾	Responsive to communication(s) filed on 3	<u>0 July 2002</u> .		
2a)⊠	This action is <b>FINAL</b> . 2b)	This action is non-final.		
3) <u></u> Dispositio	Since this application is in condition for allo closed in accordance with the practice undo of Claims	wance except for formal matt er <i>Ex parte Quayle</i> , 1935 C.D	ers, prosecution as to the med . 11, 453 O.G. 213.	rits is
4)⊠	Claim(s) <u>1,3-10 and 29-32</u> is/are pending in	the application.		
4	la) Of the above claim(s) is/are withd	rawn from consideration.		
5)	Claim(s) is/are allowed.			
6)🖾	Claim(s) <u>1,3-10 and 29-32</u> is/are rejected.			
7)	Claim(s) is/are objected to.			
8) 🔲	Claim(s) are subject to restriction and	/or election requirement.		
	on Papers	·		
9) 🔲 T	he specification is objected to by the Exami	ner.		
10) 🔲 T	he drawing(s) filed on is/are: a)□ acc	cepted or b) objected to by the	e Examiner.	
	Applicant may not request that any objection to	the drawing(s) be held in abeyan	ce. See 37 CFR 1.85(a).	
11) 🗌 T	he proposed drawing correction filed on	is: a)□ approved b)□ dis	approved by the Examiner.	
	If approved, corrected drawings are required in	reply to this Office action.		
12) 🗌 T	he oath or declaration is objected to by the B	Examiner.		
riority u	nder 35 U.S.C. §§ 119 and 120			
13) 🖾 📝	Acknowledgment is made of a claim for forei	gn priority under 35 U.S.C. §	119(a)-(d) or (f).	
a)[∑	〗All b) ☐ Some * c) ☐ None of:			
	. Certified copies of the priority docume	nts have been received.		
2	2. Certified copies of the priority docume	nts have been received in App	olication No	
	B. Copies of the certified copies of the pri application from the International E ee the attached detailed Office action for a list	Bureau (PCT Rule 17.2(a)).		
14) 🗌 Ac	knowledgment is made of a claim for domes	stic priority under 35 U.S.C. §	119(e) (to a provisional applic	ation)
	☐ The translation of the foreign language pcknowledgment is made of a claim for dome			
tachment(	•			
☐ Notice	of References Cited (PTO-892) of Draftsperson's Patent Drawing Review (PTO-948) ation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Info	mmary (PTO-413) Paper No(s) ormal Patent Application (PTO-152)	<u></u> .
Patent and Trac D-326 (Rev.		Action Summary	Part of Paper N	lo. 18

Application/Control Number: 09/103,873

Art Unit: 2815

## **DETAILED ACTION**

# Claim Rejections - 35 USC § 103

- ➤ The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

- ➤ Claims 1-10 and 29-31 are still rejected under 35 U.S.C. 103(a) as being unpatentable over Applicant's Specification in view of Matsuura et al. (US Pat. No. 5,132,774). See last Office action mailed on April 9, 2002.
- ➤ Claim 32 is rejected under 35 U.S.C. 103(a) as being unpatentable over Applicant's Specification in view of Matsuki et al. (US Patent No. 5,960,252).

Regarding claim 32, Applicant teaches a well known semiconductor device (see Figures 10A-10E) comprising: a capacitor (10) provided on a supporting substrate (1)

Art Unit: 2815

having an integrated circuit thereon (2) and including a lower electrode (7), a dielectric film (8), and an upper electrode (9); a first interlayer insulating film (11) provided so as to directly cover the capacitor; a first interconnect (14) selectively provided on the first interlayer insulating film and electrically connected to the integrated circuit and the capacitor through a first contact hole (12, 13) formed in the first interlayer insulating film; a second interlayer insulating film (15) provided so as to directly cover the first interconnect and the first interlayer insulating film; a second interconnect (17) selectively provided on the second interlayer insulating film and electrically connected to the first interconnect (14) through a second contact hole (16) formed in the second interlayer insulating film; and a passivation layer (18) provided so as to cover the second interconnect (see Figures 10A-10E). However, Applicant states that Figures 10A-10E fail to teach a second interlayer insulating film having a tensile stress. Matsuki et al. teach that is well known in the art to form first and second insulating layers (20 and 21) of a material, which is subjected to a tensile stress (see cool. 6, lines 45-50 and 55-59). Therefore, it would have been obvious to one having ordinary skill in the art at the same time the invention was made to modify Applicant's Specification to include first and second insulating layers having a tensile stress. The ordinary artisan would have been motivated to modify Applicant's Specification in the manner described above for at least the purpose of improving warp in the substrate and stress in the film applied from the substrate.

Art Unit: 2815

## Response to Arguments

Applicant's arguments filed July 30, 2002 have been fully considered but they are not persuasive. With regard to Applicant arguments about the features shown in Figures 10A-10E, Applicant acknowledges that Figures 10A-10E describe "an exemplary conventional method for fabricating a semiconductor device" (see page 2, lines 31-16 of the Specification). In other words, Applicant recognizes that the features shown in Figures 10A-10E are well known in the art. In addition, Applicant states that the description of such features is disclosed on pages 2-5 (see page 2, lines 13-14). One of such well-known features acknowledged by the Applicant is, for example, the material of the dielectric film (8), which is made of "a high dielectric constant material film or a ferroelectric material film" (see page 10, lines 26-28). Thus, the limitation incorporated to the amended claim 1 is still anticipated by Applicant's Specification, and thus, still anticipated by the combination of references presented in the Office action mailed on April 9, 2002.

Further, Applicant indicates that the problem with the prior art of Figures 10A-10E is the composition of the second interlayer insulating film (15). For instance see page 5, lines 4-10, wherein Applicant states that the second interlayer insulating film (15), made of a plasma TEOS film, provides a compressive stress over the dielectric film (8), which prevents the polarization of the dielectric material of the dielectric film (8). Note that the dielectric film is still made of a material selected from the group consisting of "a high dielectric constant material film" and "a ferroelectric material film" (see page 5, lines 9-10). Applicant proposes the use of an ozone TEOS film as the second interlayer

Application/Control Number: 09/103,873

Art Unit: 2815

insulating film to alleviate the stress acting on the capacitor (see page 22, lines 6-14) and improve the remnant polarization (page 23, lines 16-25) by providing a smooth surface over the semiconductor structure (see Figures 11A and 11B). Thus, the only difference between Applicant invention and the prior art of Figures 10A-10E is the material, which the second interlayer insulating film is formed.

The reference Matsuura et al. teaches that is well known in the art to form second interlayer insulating films (14, 35) of <u>ozone TEOS</u> (see Figures 1E, 6A-6E, col. 4, lines 61-64 and col. 5, lines 24-32) over a semiconductor structure for providing a smooth upper surface (col. 3, lines 54-57), which is what Applicant proposed as his invention. Thus, the reference Matsuura et al. cures the deficiency of the prior art taught by Applicant in Figures 10A-10E.

With regard to the claimed remnant polarization and the tensile stress, one of ordinary skills in the art recognizes that such properties are well known properties of such ozone TEOS film. For example, Matsuura et al. teach that the ozone TEOS film is deposited by an APCVD process (see col. 4, lines 61-63 and 66-68) and it is well known that APCVD silicon dioxide layers have tensile stress of, for example, 3 x 10<sup>9</sup> dynes/cm<sup>2</sup>. As evidence of this assertion, the Examiner cites the reference Wolf et al. Wolf et al. disclose well known properties of silicon oxides such as the APCVD silicon oxide (see Table 2 on page 183), which supports the Official Notice taken in the Office action mailed on April 9, 2002. Furthermore, since it is well known that ozone TEOS improves the polarization of, for example, ferroelectric capacitors, the claimed remnant of polarization was considered as an optimum value discovered by Applicant. In

Art Unit: 2815

addition, Applicant should note that the reference Matsuki et al. used in the rejection of the new claim 32 provides evidence that further supports the Examiner position taken with regard to the ozone TEOS layer. For example, Matsuki et al. teach the well-known ozone TEOS layer as the second interlayer insulating film (21) (see Figure 4) having a tensile stress (see col. 6, lines 45-48 and 55-59) and an improved remnant of polarization (See Figures 3A-3C). Therefore, Applicant's arguments are not persuasive since first, the combination of reference anticipates the claimed limitations; second, evidence was provided to support well known teachings; and finally, a motivation was provided to combine the references. As such, the rejection is considered to be proper.

#### Conclusion

> THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

.Application/Control Number: 09/103,873

Art Unit: 2815

Correspondence

Any inquiry concerning this communication or earlier communications from the

Page 7

examiner should be directed to José R Díaz whose telephone number is (703) 308-

The examiner can normally be reached on 9:00-5:00 Monday, Tuesday, 6078.

Thursday and Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Eddie Lee can be reached on (703) 308-1690. The fax phone numbers for

the organization where this application or proceeding is assigned are (703) 308-7722 for

regular communications and (703) 746-3891 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or

proceeding should be directed to the receptionist whose telephone number is (703) 308-

0956.

JRD

September 19, 2002

SUPERVISORY PATENT EXAMINER **TECHNOLOGY CENTER 2800**